# **Supplementary Information for**

**Ultra-broadband and high response of the Bi2Te3-Si heterojunction and its**

**application on photodetector at room temperature in harshworking**

### **environments**

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### **S1. Components of the PLD-grown Bi2Te<sup>3</sup> thin film**

The energy dispersive spectrum (EDS) analysis of the PLD-grown  $Bi<sub>2</sub>Te<sub>3</sub>$  thin film is shown in Fig. S1. Components of the film are slightly deviated from the ideal stoichiometric ratio, with a little excess of Bi atoms. According to previous studies, excess Bi generates p-type carriers due to the formation of Bi (Te) anti-site defects.<sup>[1](#page-7-0)</sup>



**Figure S1**. EDS analysis of the PLD-grown Bi<sub>2</sub>Te<sub>3</sub> thin film.

### **S2. Ohmic contacts between Ag (Pt) and Si (Bi2Te3)**

The current-voltage (I-V) characteristics of Ag/Si/Ag and  $Pt/Bi<sub>2</sub>Te<sub>3</sub>/Pt$  are shown in Fig. S2(a) and Fig. S2(b), respectively. The linearity of the lines reveals relatively good ohmic contact between Ag (Pt) and Si (TI).



**Figure S2**. Ohmic contacts between Ag (Pt) and Si (Bi<sub>2</sub>Te<sub>3</sub>). (a) The I-V curve of Si with Ag electrodes. (b) The I-V curve of  $Bi<sub>2</sub>Te<sub>3</sub>$  with Pt electrodes. The insets on the top left corner illustrate the structure of the devices.

# **S3. Long-term switching behavior of the device**



**Figure S3.** Time-dependent switching behavior for c.a. 1500 s. Source-drain bias: -5

V.

#### **S4. The response and recovery times of the device**

We record the current during the fast mechanical chop of the illumination. No data point is recorded at the rising and falling edge. Therefore, the rising and falling times of the device must be less than c.a. 100 ms, the shortest sampling interval of our electrical measurement instrument.



**Figure S4.** The rising and falling times of the photodetector. (a) An enlarged switching cycle. (b) Enlarged rising edge of (a). (c) Enlarged decay edge of (a). Note that the chopper (plastic sheet) can not completely block the incident light. Therefore, the base current becomes relatively large.

### **S5. Calculation of photosensitivity (S) responsivity (R) and detectivity (D\*).**

Photosensitivity (S), responsivity  $(R)$ , and detectivity  $(D^*)$  were calculated using the following equations. [2-4](#page-7-1)

$$
S = \frac{I_p - I_d}{I_d * P}
$$
  

$$
R(AW^{-1}) = \frac{I_p - I_d}{P_{opt}}
$$
  

$$
D^* = A^{\frac{1}{2}} R / (2qI_d)^{\frac{1}{2}}
$$

where  $I_p$ ,  $I_d$ ,  $P$ ,  $P_{opt}$ ,  $A$ ,  $q$  are photocurrent, dark current, incident light power density, incident light power, active area, the unit of elementary charge, respectively.

Device	Responsivity	Response/Recovery	Photosensitivity	Response range	Detectivity (cm*H)	Ref
Structure	(A/W)	time	$\text{cm}^2/\text{mW}$		$\frac{1}{z}$ / <sub>2</sub> *W <sup>-1</sup> )	
Bi <sub>2</sub> Te <sub>3</sub> /Si	1	$\leq$ 100ms/ $\leq$ 100ms	10 <sup>3</sup>	$370 \text{ nm} \sim 118.8 \text{ µm}$	$4.7*10^{10}$	Our work
GO junction	0.0236	$105$ ms/ $105$ ms	0.024	290 nm $\sim$ 1610 nm	$3.31*107$	J. Mater. Chem. C <sup>5</sup>
G/Si	0.435	$1.2 \text{ms}/3 \text{ms}$	0.26	488 nm $\sim$ 730 nm	$1.4*108$	Nano Lett <sup>6</sup>
GO/SiNW	0.009	26.5s/25.6s	3.4	532 nm $\sim$ 118.8 µm	ND	Small <sup>7</sup>
Pd/G/TI	0.006	ND	ND	632 nm $\sim$ 1550 nm	ND	Nature Photonics <sup>8</sup>
G	$\overline{4}$	ND	ND	532 nm $\sim$ 3200 nm	ND	Nature Nano <sup>9</sup>
G	8.6	>100s/>100s	${}_{0.001}$	532 nm $\sim$ 10 µm	ND	Nature Com <sup>10</sup>
G/OD	10 <sup>7</sup>	$100$ ms/ $200$ ms	ND	500 nm $\sim$ 1600 nm	$7*10^{13}$	Nature Nano <sup>11</sup>
$G-Bi2Te3$	35	$9.3$ ms/ $17.7$ ms	0.03	300 nm $\sim$ 1600 nm	ND	ACS Nano <sup>12</sup>

**Table S1.** Summary of the performances of G/GO based photodetector.





G: graphene, GO: graphene oxide, NW: nanowire, ND: no data, QD: quantum dots.

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